

UNISONIC TECHNOLOGIES CO., LTD

3N70-LC Preliminary Power MOSFET

3A, 700V N-CHANNEL POWER MOSFET

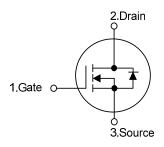
■ DESCRIPTION

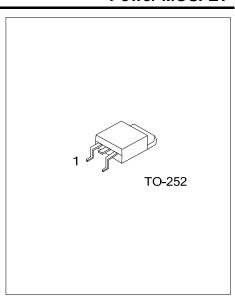
The UTC **3N70-LC** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \le 4.3 \Omega$ @ V_{GS} =10V, I_D =1.5A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

■ SYMBOL

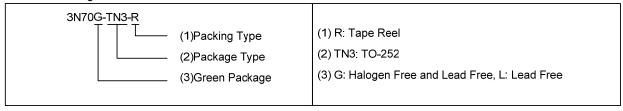




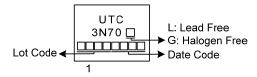
ORDERING INFORMATION

Ordering Number		Dookona	Pin Assignment			Doolsing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
3N70L-TN3-R	3N70G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



<u>www.unisonic.com.tw</u> 1 of 6

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	700	V
Gate-Source Voltage	V_{GSS}	±30	V
Continuous Drain Current	I_{D}	3	Α
Pulsed Drain Current (Note 2)	I _{DM}	6	Α
Avalanche Energy Single Pulsed (Note 3) E _{AS}	63	mJ
Peak Diode Recovery dv/dt (Note 4)	dv/dt	3.3	V/ns
Power Dissipation	P _D	45	W
Junction Temperature	TJ	+150	°C
Storage Temperature	T _{STG}	-55 ~ + 150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L = 30mH, I_{AS} = 2.0A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 3.0 A$, di/dt $\le 200 A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θ_{JA}	θ _{JA} 110		
Junction to Case	θ_{JC}	2.65 (Note)	°C/W	

Note: Device mounted on FR-4 substrate Pc board, 2oz copper, with 1inch square copper plate.

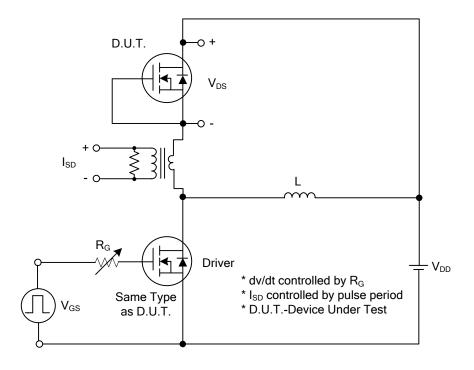
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	700			V
Drain-Source Leakage Current	I _{DSS}	$V_{DS} = 700V, V_{GS} = 0V$			10	μA
Coto Source Leakage Current Forward	- I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Gate- Source Leakage Current Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS	_					
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	$V_{GS} = 10V, I_D = 1.5A$			4.3	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}			438.6		pF
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V, f=1.0MHz		36.3		pF
Reverse Transfer Capacitance	C _{RSS}			1.98		pF
SWITCHING CHARACTERISTICS						<u>-</u>
Total Gate Charge (Note 1)	Q_G	\\ -560\\ \\ -10\\ -24		15.6		nC
Gate-Source Charge	Q_GS	V_{DS} =560V, V_{GS} =10V, I_{D} =3A I_{G} =1mA (Note 1, 2)		5.4		nC
Gate-Drain Charge	Q_GD	IG-IIIA (Note 1, 2)		2.3		nC
Turn-On Delay Time (Note 1)	$t_{D(ON)}$			6.2		ns
Turn-On Rise Time	t _R	V_{DS} =100V, V_{GS} =10V, I_{D} =3A,		15		ns
Turn-Off Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1, 2)		35.7		ns
Turn-Off Fall Time	t_{F}			28.2		ns
DRAIN-SOURCE DIODE CHARACTERISTICS	AND MAXII	MUM RATINGS		-		
Maximum Continuous Drain-Source Diode	I _S				3	Α
Forward Current					3	А
Maximum Pulsed Drain-Source Diode Forward	I _{SM}				6	Α
Current					U	^
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	I_S =3.0A , V_{GS} =0V			1.4	V
Reverse Recovery Time (Note 1)	t _{rr}	I _S =3.0A , V _{GS} =0V		310		ns
Reverse Recovery Charge	Q _{rr}	di/dt=100A/μs 3.2			μC	

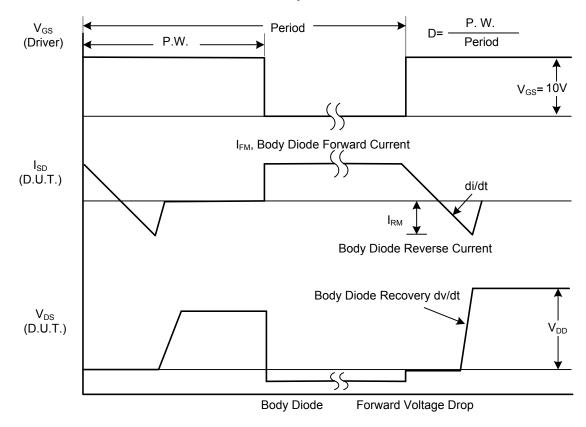
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

^{2.} Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

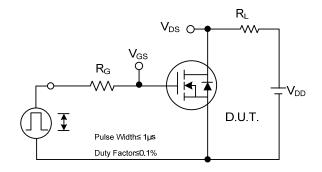


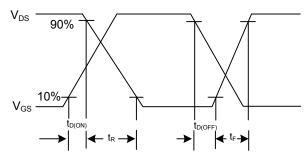
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

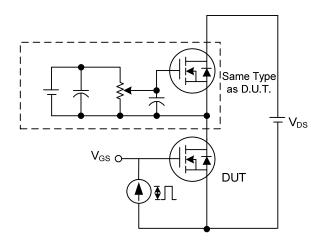
■ TEST CIRCUITS AND WAVEFORMS

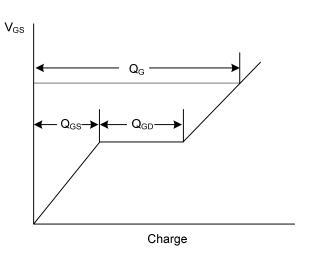




Switching Test Circuit

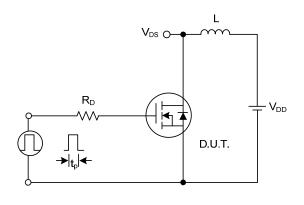
Switching Waveforms

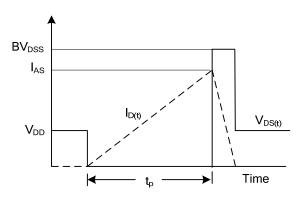




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

